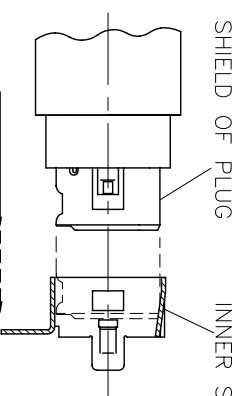
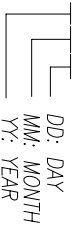


REV	ECN NO OR DESCRIPTION	REVISED	DATE
D	ECN NO. T060242	LAO	2005.08.14
E	ECN NO.070147Z CHANGE D/C ORIENTATION AND PART MARK	TANGHUI	2007.07.09
F	1.IN ACCORDANCE WITH PDR DEMAND ON THE BASIS OF ORIGINAL 2M-0402A10 INCREASE A SPECIFICATION NEWLY. 2.ECN NO.C080297-2/3/F	JUNHUA	2008.12.23
G	ECN NO. C100015	Kim	2010.01.15

- SPECIFICATIONS:
- SOLDER HEAT RESISTANCE: REFLOW SOLDERING 260° FOR 10SE
 - MARKING: MARK "S" ON REAR OF CONNECTOR.
 - TO CONFORM TO SINGATRON HAZARDOUS SUBSTANCE FREE SPEC
 - GREEN PRODUCT IDENTIFICATION MARK ON JACK:
 - GREEN PRODUCT IDENTIFICATION LABEL ON PACKAGING: **G.P. PASS**
 - FOR REFLOW SOLDERING LEAD-FREE PROCESS.
 - PRINTED DATE CODE "MMDD" ON TOP OF CONNECTOR.



A-A SECTION OF INNER SHIELD

P/N	OUTER SHIELD/PLATING
2M-0402-013	SOLDERABLE NICKEL
2M-0402A10	TIN PLATING(LEAD-FREE)

E	CONTACT TERMINAL	4	PHOSPHOR BRONZE 0.3T	SILVER PLATING
D	OUTER SHIELD	1	BRASS 0.4T	SEE"TABLE"
C	INNER SHIELD	1	BRASS 0.4T	NICKEL PLATING
B	COVER	1	HIGH TEMP THERMOPLASTIC	BLACK COLOR
A	BODY	1	HIGH TEMP THERMOPLASTIC	BLACK COLOR
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR

UNLESS OTHERWISE SPECIFIED TOLERANCES

Singatron Enterprise Co., Ltd.
信登企業股份有限公司

DECIMALS:	ANGLES:	TITLE
X : ±0.5	X : ±2°	4P SOCKET
XX : ±0.3	XX : ±1°	DWN Kim PART NO. 2M-0402XXXX
XXX : ±0.3	XXX : ±1°	CHKD MUYUQIN SCALE 2:1 UNIT: mm
X:XX : ±0.2		APVD ROBIN SIZE: A3 SHEET: 10F1 REV: G

CUSTOMER COPY

RECOMMENDED PCB LAYOUT
(TOP VIEW)(TOL. ±0.05) THK:1.2mm

A B C D E F

1 2 3 4 5 6 7 8